# **BLF8G27LS-140V**

# **Power LDMOS transistor**

**AMPLEON** 

Rev. 4 — 1 September 2015

**Product data sheet** 

### 1. Product profile

#### 1.1 General description

140 W LDMOS power transistor with improved video bandwidth for base station applications at frequencies from 2600 MHz to 2700 MHz.

Table 1. Typical performance

Typical RF performance at  $T_{case}$  = 25 °C in a common source class-AB production test circuit.

| Test signal      | f            | $I_{Dq}$ | V <sub>DS</sub> | P <sub>L(AV)</sub> | $G_p$ | $\eta_D$ | ACPR               |
|------------------|--------------|----------|-----------------|--------------------|-------|----------|--------------------|
|                  | (MHz)        | (mA)     | (V)             | (W)                | (dB)  | (%)      | (dBc)              |
| 2-carrier W-CDMA | 2600 to 2700 | 1300     | 32              | 45                 | 17.4  | 30       | -32 <u>[1]</u>     |
| 2-carrier W-CDMA | 2600 to 2700 | 1300     | 28              | 35                 | 17.0  | 29       | -33 <del>[1]</del> |

<sup>[1]</sup> Test signal: 3GPP test model 1; 64 DPCH; PAR = 8.4 dB at 0.01 % probability on CCDF; carrier spacing 5 MHz.

#### 1.2 Features and benefits

- Excellent ruggedness
- High efficiency
- Low thermal resistance providing excellent thermal stability
- Decoupling leads to enable improved video bandwidth (100 MHz typical)
- Lower output capacitance for improved performance in Doherty applications
- Designed for low memory effects providing excellent pre-distortability
- Internally matched for ease of use
- Integrated ESD protection
- Compliant to Directive 2002/95/EC, regarding Restriction of Hazardous Substances (RoHS)

#### 1.3 Applications

RF power amplifier for W-CDMA base stations and multi carrier applications in the 2600 MHz to 2700 MHz frequency range

### 2. Pinning information

Table 2. Pinning

| Pin | Description      | Simplified outline | Graphic symbol |
|-----|------------------|--------------------|----------------|
| 1   | drain            | 4                  | 4.4.5          |
| 2   | gate             | 4 5                | 1, 4, 5        |
| 3   | source [1]       |                    | 2              |
| 4,5 | video decoupling | 3                  | 2 - 7          |
| 6   | n.c.             |                    | aaa-003884     |
| 7   | n.c.             | 2                  |                |

<sup>[1]</sup> Connected to flange.

### 3. Ordering information

Table 3. Ordering information

| Type number    | Packag | je  |          |
|----------------|--------|---|----------|
|                | Name   | Description                                     | Version  |
| BLF8G27LS-140V | -      | earless flanged LDMOST ceramic package; 6 leads | SOT1120B |

### 4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol            | Parameter            | Conditions | Min  | Max  | Unit |
|-------------------|----------------------|------------|------|------|------|
| $V_{DS}$          | drain-source voltage |            | -    | 65   | V    |
| $V_{GS}$          | gate-source voltage  |            | -0.5 | +13  | V    |
| T <sub>stg</sub>  | storage temperature  |            | -65  | +150 | °C   |
| Tj                | junction temperature |            | -    | 200  | °C   |
| T <sub>case</sub> | case temperature     | [1]        | -    | 150  | °C   |

<sup>[1]</sup> Continuous use at maximum temperature will affect MTTF.

### 5. Recommended operating conditions

Table 5. Operating conditions

| Symbol            | Parameter        | Conditions | Min             | Тур | Max  | Unit |
|-------------------|------------------|------------|-----------------|-----|------|------|
| T <sub>case</sub> | case temperature |            | <del>-4</del> 0 |     | +125 | °C   |

### 6. Thermal characteristics

Table 6. Thermal characteristics

| Symbol               | Parameter                                | Conditions                       | Тур  | Unit |
|----------------------|--|----------------------------------|------|------|
| R <sub>th(j-c)</sub> | thermal resistance from junction to case | $T_{case}$ = 80 °C; $P_L$ = 55 W | 0.27 | K/W  |

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#### 7. Characteristics

Table 7. DC characteristics

 $T_i = 25$  °C; unless otherwise specified.

| Symbol               | Parameter                        | Conditions   | Min | Тур  | Max | Unit |
|----------------------|----------------------------------|--|-----|------|-----|------|
| V <sub>(BR)DSS</sub> | drain-source breakdown voltage   | $V_{GS} = 0 \text{ V}; I_D = 2.16 \text{ mA}$                      | 65  | -    | -   | V    |
| V <sub>GS(th)</sub>  | gate-source threshold voltage    | V <sub>DS</sub> = 10 V; I <sub>D</sub> = 216 mA                    | 1.5 | 1.9  | 2.3 | ٧    |
| I <sub>DSS</sub>     | drain leakage current            | V <sub>GS</sub> = 0 V; V <sub>DS</sub> = 28 V                      | -   | -    | 4.2 | μΑ   |
| I <sub>DSX</sub>     | drain cut-off current            | $V_{GS} = V_{GS(th)} + 3.75 \text{ V};$<br>$V_{DS} = 10 \text{ V}$ | _   | 40   | -   | Α    |
| I <sub>GSS</sub>     | gate leakage current             | V <sub>GS</sub> = 11 V; V <sub>DS</sub> = 0 V                      | -   | -    | 420 | nA   |
| g <sub>fs</sub>      | forward transconductance         | $V_{DS} = 10 \text{ V}; I_D = 10.8 \text{ A}$                      | -   | 16   | -   | S    |
| R <sub>DS(on)</sub>  | drain-source on-state resistance | $V_{GS} = V_{GS(th)} + 3.75 \text{ V};$<br>$I_D = 7.56 \text{ A}$  | -   | 0.06 | -   | Ω    |

#### Table 8. RF characteristics

Test signal: 2-carrier W-CDMA; PAR 8.4 dB at 0.01 % probability on CCDF; 3GPP test model 1; 64 DPCH;  $f_1$  = 2627.5 MHz;  $f_2$  = 2687.5 MHz; RF performance at  $V_{DS}$  = 32 V;  $I_{Dq}$  = 1300 mA;  $T_{case}$  = 25 °C; unless otherwise specified; in a class-AB production test circuit.

| Symbol             | Parameter                            | Conditions                | Min  | Тур  | Max  | Unit |
|--------------------|--------------------------------------|---------------------------|------|------|------|------|
| G <sub>p</sub>     | power gain                           | P <sub>L(AV)</sub> = 45 W | 15.8 | 17.4 | 18.7 | dB   |
| RLin               | input return loss                    | P <sub>L(AV)</sub> = 45 W | -    | -18  | -8   | dB   |
| $\eta_{D}$         | drain efficiency                     | P <sub>L(AV)</sub> = 45 W | 27   | 30   | -    | %    |
| ACPR <sub>5M</sub> | adjacent channel power ratio (5 MHz) | P <sub>L(AV)</sub> = 45 W | -    | -32  | -29  | dBc  |

#### 8. Test information

#### 8.1 Ruggedness in class-AB operation

The BLF8G27LS-140V is capable to withstand a load mismatch corresponding to VSWR = 10 : 1 through all phases under the following conditions:  $V_{DS}$  = 32 V;  $I_{Dq}$  = 1300 mA;  $P_{L}$  = 180 W (CW); f = 2620 MHz.

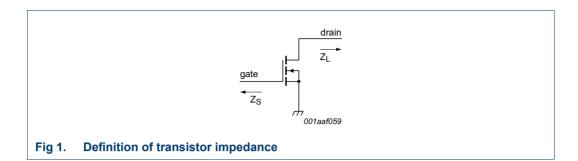
#### 8.2 Impedance information

Table 9. Typical impedance

 $I_{Dq} = 1300 \text{ mA}$ ; main transistor  $V_{DS} = 32 \text{ V}$ .

| f     | Z <sub>S</sub> [1] | Z <sub>L</sub> [1] |
|-------|--------------------|--------------------|
| (MHz) | (Ω)                | (Ω)                |
| 2600  | 2.0 – j4.8         | 1.4 – j3.1         |
| 2700  | 3.5 – j4.8         | 1.4 – j3.1         |

[1]  $Z_S$  and  $Z_L$  defined in <u>Figure 1</u>.



#### 8.3 VBW in class-AB operation

The BLF8G27LS-140V shows 100 MHz (typical) video bandwidth in class-AB test circuit in 2.6 GHz to 2.7 GHz band at  $V_{DS}$  = 32 V and  $I_{Dq}$  = 1.3 A.

#### 8.4 Test circuit

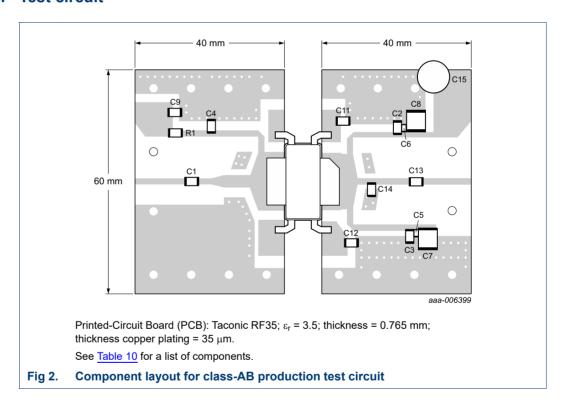


Table 10. List of components

For test circuit see Figure 2.

| Component           | Description                       | Value            | Remarks |
|---------------------|-----------------------------------|------------------|---------|
| C1, C2, C3, C4, C13 | multilayer ceramic chip capacitor | 10 pF [1]        | ATC100B |
| C14                 | multilayer ceramic chip capacitor | 0.5 pF [1]       | ATC100B |
| C5, C6              | multilayer ceramic chip capacitor | 1 μF, 50 V [2]   | Murata  |
| C7, C8              | multilayer ceramic chip capacitor | 10 μF, 50 V [2]  | Murata  |
| C9                  | multilayer ceramic chip capacitor | 4.7 μF, 50 V [2] | Murata  |

 Table 10.
 List of components ...continued

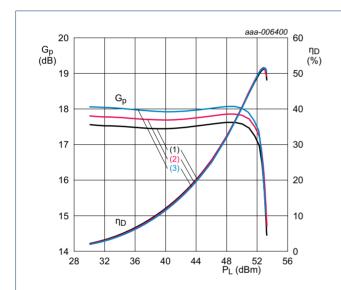
For test circuit see Figure 2.

| Component | Description                       | Value            | Remarks          |
|-----------|-----------------------------------|------------------|------------------|
| C11, C12  | multilayer ceramic chip capacitor | 4.7 μF, 50 V [2] | Murata           |
| C15       | electrolytic capacitor            | 470 μF, 63 V     |                  |
| R1        | chip resistor                     | 3.9 Ω            | Philips SMD 1206 |

- [1] American Technical Ceramics type 100B or capacitor of same quality.
- [2] Murata or capacitor of same quality.

#### 8.5 Graphical data

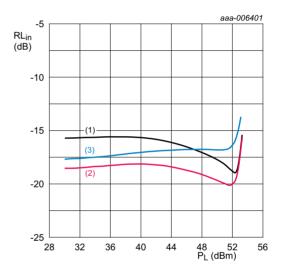
#### 8.5.1 CW pulse



 $V_{DS}$  = 32 V;  $I_{Dq}$  = 1300 mA;  $t_p$  = 100  $\mu s; \, \delta$  = 10 %.

- (1) f = 2620 MHz
- (2) f = 2655 MHz
- (3) f = 2690 MHz

Fig 3. Power gain and drain efficiency as function of load power; typical values

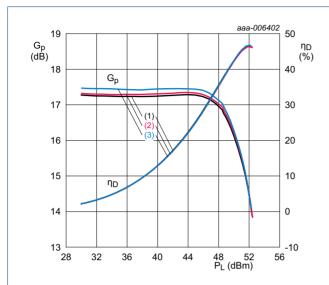


 $V_{DS}$  = 32 V;  $I_{Dq}$  = 1300 mA;  $t_p$  = 100  $\mu$ s;  $\delta$  = 10 %.

- (1) f = 2620 MHz
- (2) f = 2655 MHz
- (3) f = 2690 MHz

Fig 4. Input return loss as a function of load power; typical values

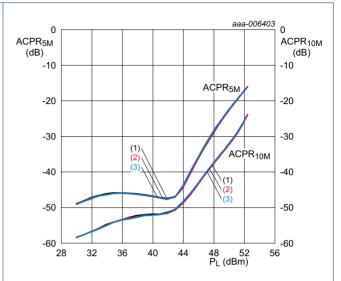
#### 8.5.2 2-Carrier W-CDMA



 $V_{DS} = 32 \text{ V}; I_{Dq} = 1300 \text{ mA}.$ 

- (1) f = 2620 MHz
- (2) f = 2655 MHz
- (3) f = 2690 MHz

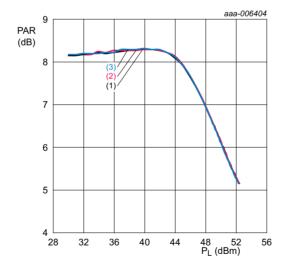
Fig 5. Power gain and drain efficiency as function of load power; typical values



 $V_{DS} = 32 \text{ V}; I_{Dq} = 1300 \text{ mA}.$ 

- (1) f = 2620 MHz
- (2) f = 2655 MHz
- (3) f = 2690 MHz

Fig 6. Adjacent channel power ratio (5MHz) and adjacent channel power ratio (10MHz) as function of load power; typical values

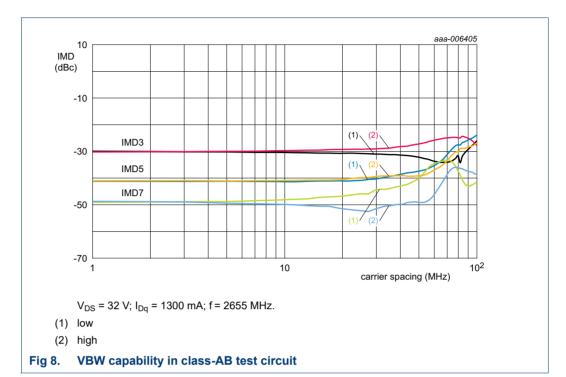


 $V_{DS} = 32 \text{ V}; I_{Dq} = 1300 \text{ mA}.$ 

- (1) f = 2620 MHz
- (2) f = 2655 MHz
- (3) f = 2690 MHz

Fig 7. Peak-to-average power ratio as a function of load power; typical values

#### 8.5.3 2-Tone VBW



### 9. Package outline

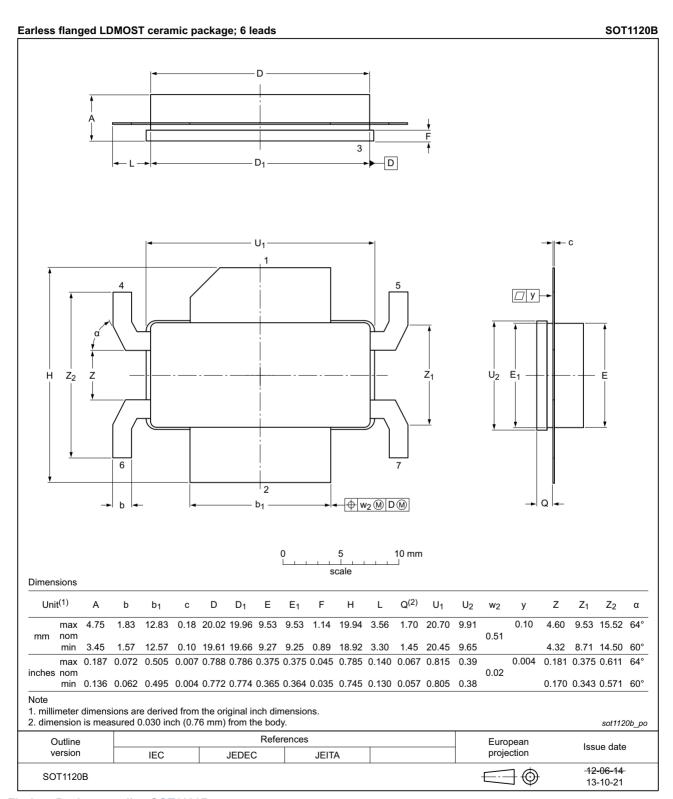


Fig 9. Package outline SOT1120B

### 10. Abbreviations

Table 11. Abbreviations

| Acronym | Description   |
|---------|---|
| 3GPP    | 3rd Generation Partnership Project                      |
| CCDF    | Complementary Cumulative Distribution Function          |
| CW      | Continuous Wave   |
| DPCH    | Dedicated Physical CHannel                              |
| ESD     | ElectroStatic Discharge                                 |
| LDMOS   | Laterally Diffused Metal Oxide Semiconductor            |
| LDMOST  | Laterally Diffused Metal Oxide Semiconductor Transistor |
| MTTF    | Mean Time To Failure                                    |
| PAR     | Peak-to-Average Ratio                                   |
| SMD     | Surface Mounted Device                                  |
| VBW     | Video BandWidth   |
| VSWR    | Voltage Standing Wave Ratio                             |
| W-CDMA  | Wideband Code Division Multiple Access                  |

### 11. Revision history

Table 12. Revision history

| Document ID        | Release date   | Data sheet status  | Change notice | Supersedes         |
|--------------------|--|--------------------|---------------|--------------------|
| BLF8G27LS-140V#4   | 20150901   | Product data sheet |               | BLF8G27LS-140V v.3 |
| Modifications:     | <ul> <li>The format of this document has been redesigned to comply with the new identity guidelines of Ampleon.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul> |                    |               |                    |
| BLF8G27LS-140V v.3 | 20150501   | Product data sheet | -             | BLF8G27LS-140V v.2 |
| BLF8G27LS-140V v.2 | 20130327   | Product data sheet | -             | BLF8G27LS-140V v.1 |
| BLF8G27LS-140V v.1 | 20130307   | Product data sheet | -             | -                  |

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## **AMPLEON**

# **BLF8G27LS-140V**

#### **Power LDMOS transistor**

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